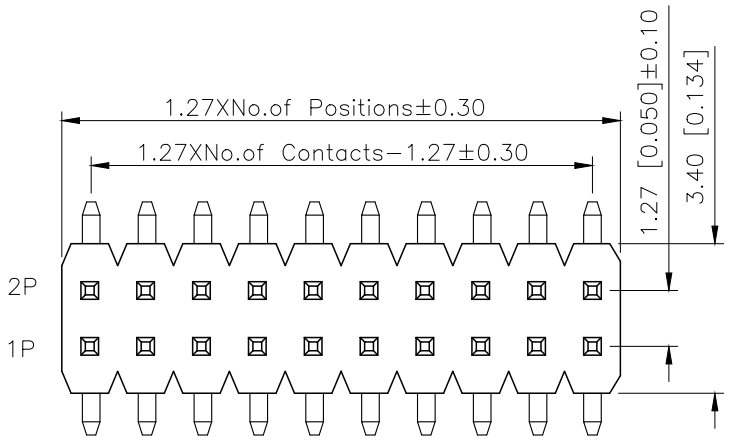
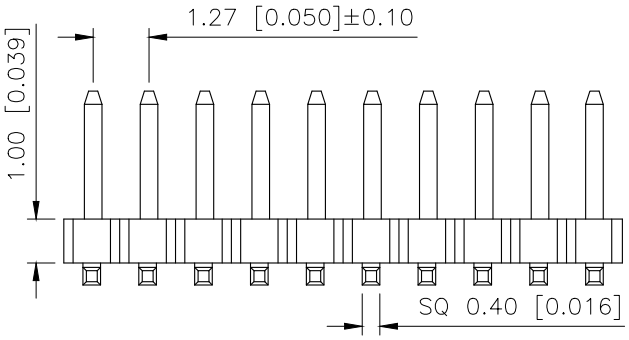
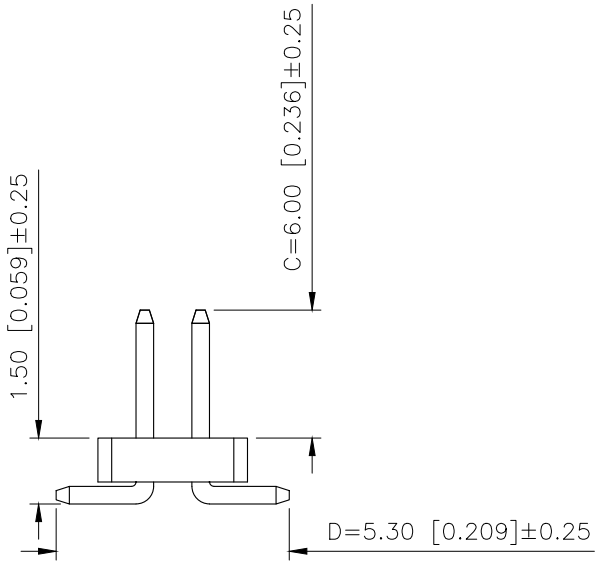
REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	2025.2.24	阿树
/	N/A		/	/	/







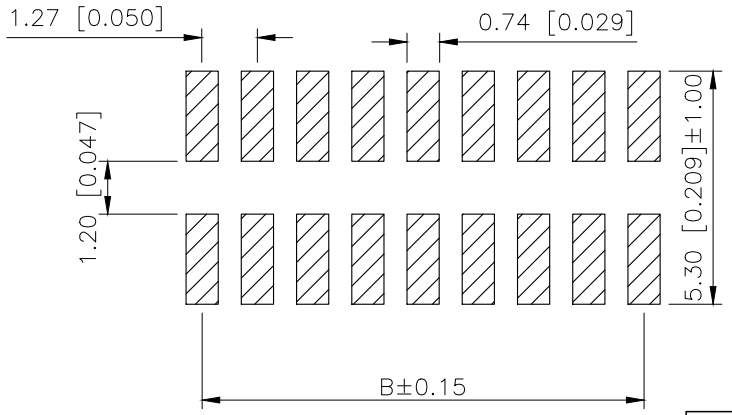
SPECIFICATIONS
Rated Current:1.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c~+105°c

Contact Material:Brass
Contact Plating:Au1U
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

PART NO.:

X1321 W V S−2x08 J−C60 D53
① ② ③ ④ ⑤ ⑥ ⑦ ⑧

①Series No
②Category:W−Wafer
③Welding Board Angle:V−Stright 180°
④Welding Way:S−SMT
⑤Row No.Pin No:2xXX−2x02~2x40Pin
⑥Plastic Height:J=1.0mm
⑦Pin Length:C=6.0mm
⑧Pin Length:D=5.3mm



P.C.B LAYOUT

X1321WVS−2x08J−C60D53	PA6T	Brass	X1321F
PART NO	Material	Material(Pin)	Suitable XKB Female

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERAuCES	

XKB 星创 Connection

DESIGN	阿树	VIEW:	MODEL TYPE: 1.27mm BTB Connector
CHECKED		UNIT: mm/in	PART NO.: X1321WVS−2x08J−C60D53
APPROVED		SIZE: A4	DWG NO.: X−X1321WVS−2x08J−C60D53

XKB INDUSTRIAL PRECISION CO.,LIMITED

SCALE	PAGE	REVISION
N/A	1/1	A1